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# **H8S Family**

## SCI Continuous Transmission and Reception

#### Introduction

Transmits and receives 8-byte data between the H8S/2339 and H8/3687 in the clock synchronous mode. The DMAC is used.

## **Target Device**

H8S/2339

#### **Contents**

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## 1. Specifications

- 1. This sample task sets the SCI of the H8S/2339 in the clock synchronous mode and transmits and receives 8-byte data to and from the H8/3687 continuously.
- 2. This sample task uses the DMAC to transfer data from memory to TDR (transmit data register) and from RDR (receive data register) to memory without the intervention of the CPU.
- 3. The transmitting side becomes the clock master.

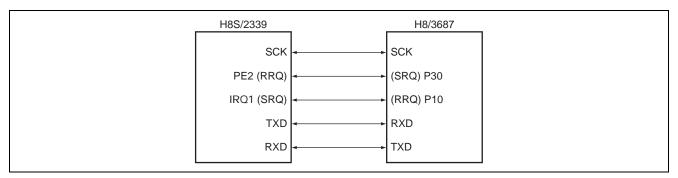


Figure 1 Block Diagram of the Clock Synchronous Mode SCI by the H8S/2339



#### 2. Description of Functions

The H8S/2339 internal functions to be used by this sample task are shown in figure 2. This sample task performs high-speed serial communication, using the DMAC0A, DMAC0B and SCI1 as shown in figure 2.

[Data Buffer] Buffer RAM for storing data to be transmitted and received.

[DMAC0A] Operates in the sequential mode. Starts up by an SCI transmission completion interrupt and transfers

the contents in the transmit data buffer to the SCI.

[DMAC0B] Operates in the sequential mode. Starts up by an SCI reception completion interrupt and transfers

receive data to the reception data buffer.

[SCI1] Transmits and receives serial data.

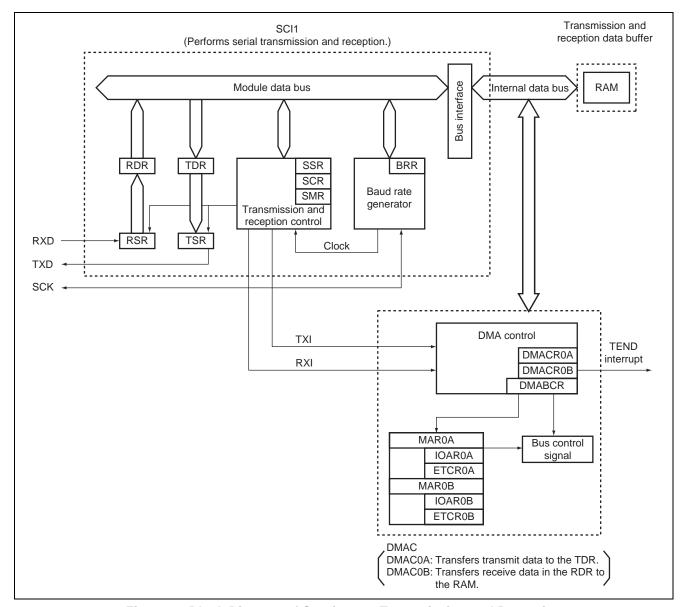


Figure 2 Block Diagram of Continuous Transmission and Reception



## 3. Principles of Operation

#### 1. Data Transmission

The principles of operations used during data transmission is shown in figure 3. This sample task controls the I/O port and the clock synchronous mode SCI at the timing shown in figure 3 to make an interface.

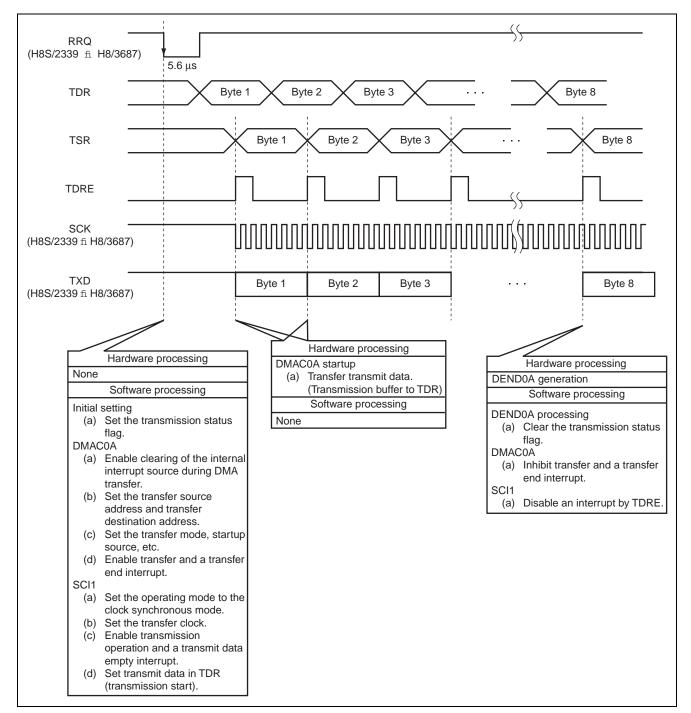


Figure 3 Principles of Operations Used of Data Transmission



#### 2. Data Reception

The principles of operations used during data reception are shown in figure 4. This sample task controls the I/O port and the clock synchronous mode SCI as shown in figure 4 to make an interface.

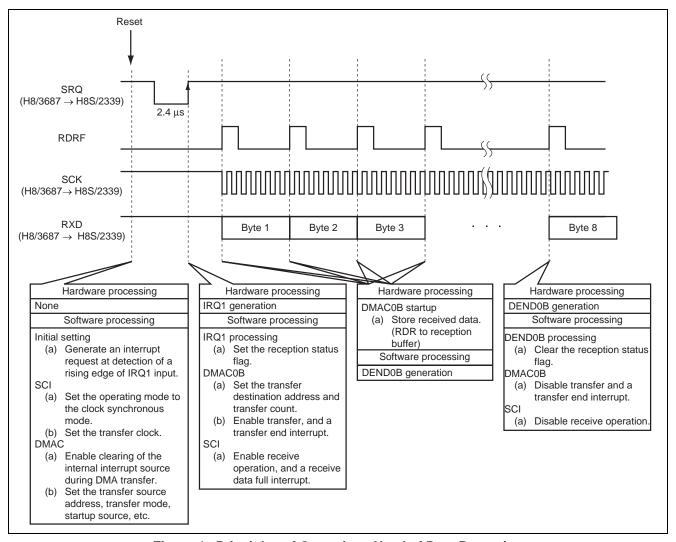


Figure 4 Principles of Operations Used of Data Reception



## 4. Description of Software

## 1. Description of Modules

Module Name	Label Name	Function
Main routine	hiscimn	Performs initial setting of the I/O port, SCI, and DMAC.
Data transmission	txstart	Enables the DMAC to transfer data and starts SCI transmission operation.
Data reception	rxstart	Starts up by an IRQ1 interrupt, enables DMAC transfer, and starts reception operation of the SCI.
Transmission completion	txend	Starts up by a DMAC0A transfer end interrupt, clears stat_tx and disables transmission interrupt processing.
Reception completion	rxend	Starts up by a DMAC0B transfer end interrupt, clears stat_rx and disables reception processing.

## 2. Description of Arguments

Element	Function	Data Length	Used in	I/O
stat_tx	t_tx Flag indicating transmission in progress unsigned char Data 0: Transmission end		Data transmission	Output
	<ol> <li>Transmission in progress or before start of transmission</li> </ol>		Main routine	Input
stat_rx	Flag indicating reception in progress	unsigned char	Main routine	Input
	0: Reception end		Data transmission	Output
	<ol> <li>Reception in progress or before start of reception</li> </ol>			



## 3. Internal Registers Used

Element	Register Name	Function		
SCI1	SMR1	Sets the SCI as follows:		
		<ul> <li>Sets the SCI operating mode to the clock synchronous mode.</li> </ul>		
		<ul> <li>Sets the clock source of the baud generator to φ.</li> </ul>		
	SCR1	Sets the SCI as following during transmission and reception		
		respectively:		
		Transmission: Enables a transmit data empty interrupt.		
		Enables transmit operation.		
		Sets the SCK pin to output a synchronizing clock.		
		Reception: Enables a receive data full interrupt.		
		Enables receive operation.		
		Sets the SCK pin to input a synchronizing clock.		
	SSR1	Transmission: Clears TDRE to start transmission.		
		Reception: Clears RDRF to start reception.		
	RDR1	Stores received data.		
	TDR1	Sets data to be transmitted.		
	BRR1	Sets the transfer rate.		
DMAC	DMABCR	Sets the DMAC0A and DMAC0B as follows:		
		<ul> <li>Sets transfer mode to short-address mode.</li> </ul>		
SCI1		<ul> <li>Enables an internal interrupt source to be cleared during DMA transfer.</li> </ul>		
		Enables data transfer and a transfer end interrupt.		
	DMACR0A	Sets the DMAC0A as follows:		
		Sets the data size to bytes.		
		Sets increment of MAR.		
		Sets data transfer in the sequential mode.		
		Sets the data transfer direction (ch0A: MAR to IOAR)		
		Sets an SCI transmission completion interrupt as the startup		
		source.		
	MAR0A	Sets the transmission buffer address.		
	IOAR0A	Sets the TDR address.		
	ETCR0A	Sets the transfer count.		
	DMACR0B	Sets the DMAC0B as follows:		
		Sets the data size to bytes.		
		Sets increment of MAR.		
		Sets data transfer in the sequential mode.		
		Sets the data transfer direction (ch0B: IOAR to MAR)		
		Sets an SCI reception completion interrupt as the startup		
		source.		
	MAR0B	Sets the reception buffer address.		
	IOAR0B	Sets the RDR address.		
	ETCR0B	Sets the transfer count.		
I/O	PEDDR	Sets I/O of port E.		
., .	PEDR	Transmits RRQ.		
	ILDIN	Hansinio MA.		



# H8S Family SCI Continuous Transmission and Reception

Element	Register Name	Function
Interrupt	IER	Enables an IRQ1 interrupt.
controller	ISCR	Sets an interrupt request to be generated at detection of a rising edge of IRQ1.
	ISR	Indicates the IRQ1 input state.
MSTPCR		Cancels the SCI and DMAC module stop mode.

## 4. RAM Usage

Table below describes RAM usage in this sample task.

Element	Function	Data Length	Used in
buffer	Stores receive data.	8 bytes	Main routine
da.data[0]-[7]	Stores transmit data. Values set in this sample task: H'68, H'38, H'73, H'5F, H'32, H'33, H'33, and H'39.	8 bytes	Main routine, data transmission



#### 5. PAD

#### 1. Main Routine

SCI sequential transmission and reception

Cancel SCI and DMAC module stop mode.

#### Set SCR1 as follows:

- · Transmission is disabled.
- · Reception is disabled.

Set H'04 in PEDDR. PEDR, and RRQ to output.

#### Set DMABCR0A as follows:

- · Short-address mode
- Internal interrupt clear enabled at DMA transmission

Set transfer destination address (IOAR0A) to

Set transfer source address (MAR0A) to da.data[0].

Set transfer count (ETCR0A) to H'0008.

#### Set DMACR0A as follows:

- Byte size as data size
- MAR increment
- · Sequential mode as data transfer
- Transfer direction (MAR → IOAR)
- SCI transmission completion interrupt as the startup source

#### Set DMABCR0B as follows:

- · Short-address mode
- Internal interrupt clear enabled at DMA transmission

Set transfer source address (IOAR0B) to RDR1.

Set transfer destination address (MAR0B) to buffer.

Set transfer count (ETCR0B) to H'08.

#### Set DMACR0B as follows:

- Byte size as data size
- MAR increment
- · Sequential mode as data transfer
- Transfer direction (IOAR → MAR)
- SCI reception completion interrupt as the startup source

Set flag indicating write/read in progress

Request interrupt at IRQ rising edge.

Clear IRQ1 status flag.

Enable IRQ1 interrupt.

Clear I flag to enable interrupt.

While(stat\_rx)!= 0 reception ended?

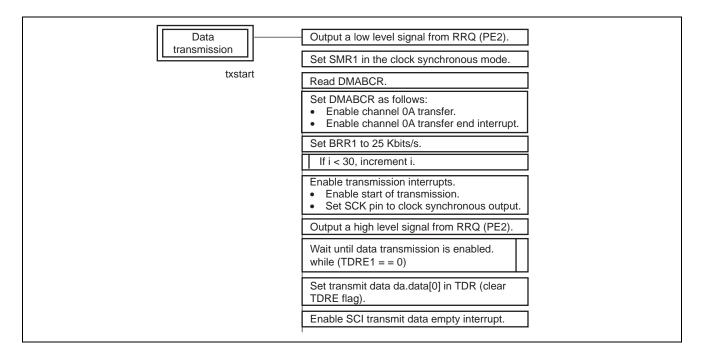
Data transmission

txstart

while (1)

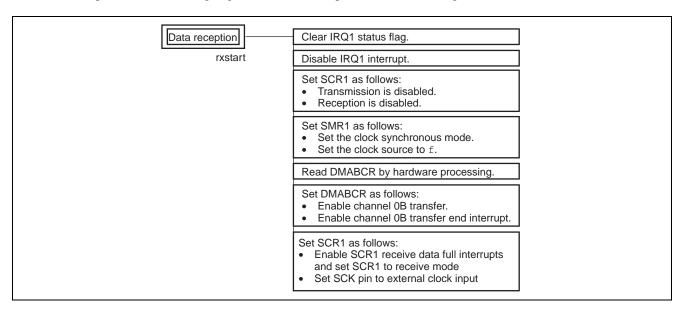


#### 2. Data Transmission



#### 3. Data Reception

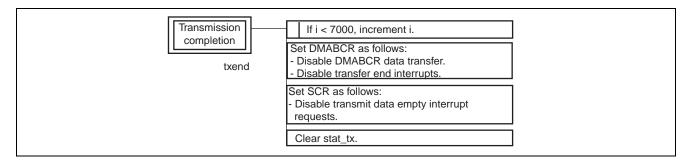
An interrupt occurs at the rising edge of the IRQ1, and performs the following.



# H8S Family SCI Continuous Transmission and Reception

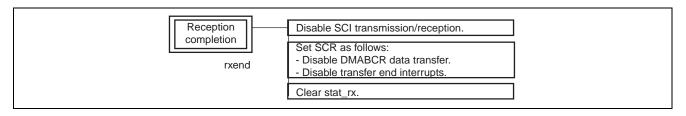
#### 4. Transmission Completion

An interrupt occurs when the data transmission of DMAC channel 0A completes, and performs the following.



#### 5. Reception Completion

An interrupt occurs when the data reception of DMAC channel 0B completes, and performs the following.





## **Revision Record**

		Descript	ion		
Rev.	Date	Page	Summary		
1.00	Feb.17.05	_	First edition issued		



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